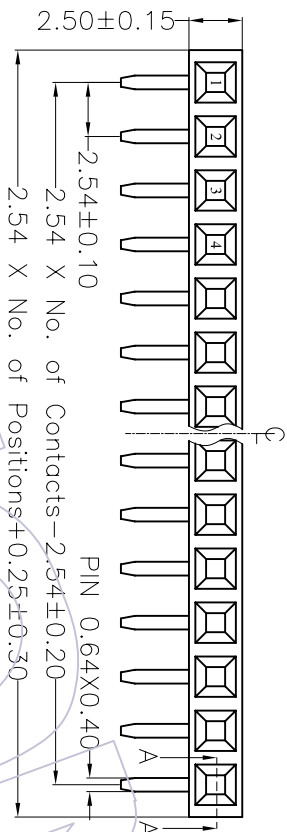
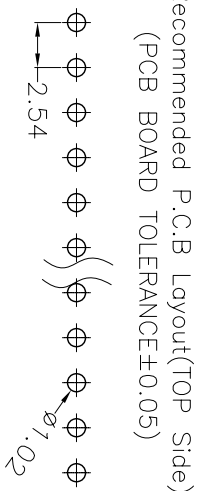


HSP

NOTES:

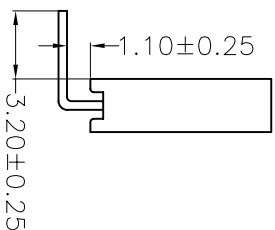
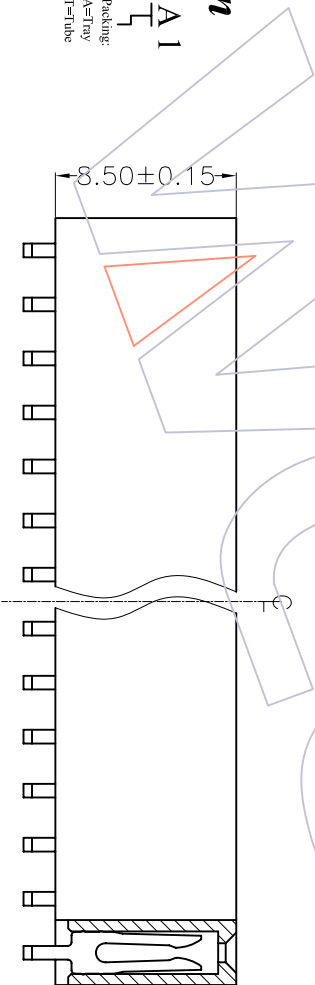
Current Rating: 3.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C
 Contact Material: Phosphor Bronze or Brass
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T or PBT+30%G.F UL94V-0



Ordering Information

2185-1XX RXX XYN A1

No. of Pins per ROW: 02-40PIN
 Contact Plating: GO=Gold Flash, GI=3μ"Gold, GS=5μ"Gold, GE=15μ"Gold
 Insulator: A=PBT, C=PA6T
 Packing: A=Tray, T=Tube
 SN=90°Gold, SO=Gold Flash/Tin, SI=3μ"Gold/Tin, S2=5μ"Gold/Tin, S3=10μ"Gold/Tin, S4=15μ"Gold/Tin, S5=30μ"Gold/Tin, SN=Tin



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	08.03.12	SCALE	4:1	 WCON 维峰五金电子有限公司 WAFER HARDWARE ELECTRONICS CO.,LTD	PART NO.	2185-1XXXXXXYN1
A0	08/03/12	NEW			X.X ±0.40 X.XX ±0.25 X.XXX ±0.15 Angle ± 3'	DESIGN CHECK			UNIT mm SIZE A4 SHEET 1/1	PROJ.		TITLE: FH2.54 SINGLE 90° H=8.5	
1					DIM	APPROVE					Customer NO.		